

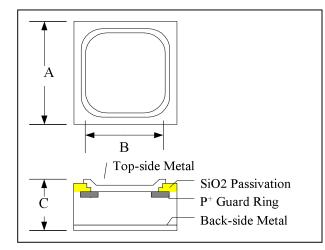
SCHOTTKY DIE SPECIFICATION Product Name: BWS-97-30-SA

General Description: 97mil 30V Standard Barrier

ELECTRICAL CHARACTERISTICS	SYM	Spec. Limit	UNIT
Reverse Breakdown Voltage: Ir=0.20mA	VBRM	35	Volt
Average Rectified Forward Current	IFAV	10.0	Amp
Maximum Instantaneous Forward Voltage			
@ 10 Amperes, Ta=25°C	VF MAX	0.460	Volt
Maximum Instantaneous Reverse Current			
VR= 33 Volt, Ta=25°ℂ	IR MAX	0.045	mA
MAXIMUM RATINGS			
Nonrepetitive Peak Surge Current			
Semi-Sine Wave, Duty = 8.3ms \ 1cycle	IFSM	150	Amp
Operating Junction Temperature	Tj	125	$^{\circ}\!\mathbb{C}$
Storage Temperatures	TSTG	-50 to +125	$^{\circ}\!\mathbb{C}$

- 1. Specification is applied to die only. Actual performance may degrade when assembled. BW does not guarantee device performance after assembly.
- 2. Suggest to storage in Nitrogen cabinet, 45-60% RH, 22-26 °C for 6 months.
- 3. Data sheet information is subjected to change without notice.
- 4. Suggest Soldering profile (Pb92.5%,5%Sn,Ag2.5%): Soldering peak Temp. 340~350 $\,^{\circ}$ C 3~5min.

DICE OUTLINE DRAWING



DIM	ITEM	μ m	Mil
Α	Die Size	2464	97.00
В	Top Metal Pad Size	2260	89.10
С	Thickness	280	11.00

(1)Cutting street width is around 40μm.

(2)Both of top-side and back-side metals are Ti/Ni/Ag.

(3) Top-side Ti/Ni thk: 0.42um, Ag thk: 3.5um

(4) Thickness(C) tolerance: +/-10um